

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SanDisk Corporation	04/04/2011
RECEIVING PARTY DATA	
Name:	SanDisk Technologies Inc.
Street Address:	6900 North Dallas Parkway
Internal Address:	Two Legacy Town Center
City:	Plano
State/Country:	TEXAS
Postal Code:	75024
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	7807529
CORRESPONDENCE DATA	
Fax Number:	(408)801-9019
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	4088012863
Email:	simona.benjamin@sandisk.com
Correspondent Name:	SanDisk Corporation
Address Line 1:	601 Mccarthy Boulevard
Address Line 2:	Patent Department/Simona Benjamin
Address Line 4:	Milpitas, CALIFORNIA 95035
ATTORNEY DOCKET NUMBER:	SDA-1260-US
NAME OF SUBMITTER:	Simona Benjamin
Total Attachments: 5 source=page 18#page1.tif source=page 18#page2.tif source=page 18#page3.tif source=page 18#page4.tif source=page 18#page5.tif	

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ASSIGNMENT

WHEREAS, SanDisk Corporation, a Delaware corporation, doing business at 601 McCarthy Boulevard, Milpitas, CA 95035 (hereinafter referred to as **ASSIGNOR**), holds right, title and interest throughout the world in and to the patents and patent applications set forth in the attached Exhibit A, together with all divisions, continuations, or continuations-in-part thereof, and all patents issuing thereon including reissues, renewals, substitutions, re-examinations and extensions thereof, and any and all corresponding foreign patents and patent applications (hereinafter referred to as, collectively, **THE ASSIGNED PATENT RIGHTS**);

WHEREAS, SanDisk Technologies Inc., a Texas corporation, doing business at Two Legacy Town Center, 6900 North Dallas Parkway, Plano, Texas 75024, (hereinafter referred to as **ASSIGNEE**), is desirous of acquiring the full and exclusive right, title and interest in **THE ASSIGNED PATENT RIGHTS**;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, **ASSIGNOR** hereby assigns, transfers and conveys unto the said **ASSIGNEE**, and **ASSIGNEE** accepts, all of **ASSIGNOR**'s right, title and interest throughout the world in and to **THE ASSIGNED PATENT RIGHTS** and to all Letters Patent or applications or similar legal protection, not only in the United States and its territorial possessions, but in all countries foreign thereto to be obtained for **THE ASSIGNED PATENT RIGHTS**, and to any continuation, division, renewal, substitute or reissue thereof or any legal equivalent thereof in the United States or a foreign country for the full term or terms for which the same may be granted, including all priority rights under the International Convention; and **ASSIGNOR** hereby authorizes and requests the United States Commissioner of Patents and Trademarks and any officials of foreign countries whose duty it is to issue patents on applications as aforesaid, to issue all patents for **THE ASSIGNED PATENT RIGHTS** to **ASSIGNEE** in accordance with the terms of this **ASSIGNMENT** but subject to reserved rights including but not limited to those previously retained by, granted to, or owned by, the United States government, educational institutions or both and hereby transfers and conveys all rights of action, power and benefit belonging to or accruing from **THE ASSIGNED PATENT RIGHTS** including the right to undertake proceedings to recover past and future damages and claim all other relief in respect of any acts of infringement thereof whether such acts shall have been committed before or after the date of this assignment.

No other rights, immunities, or licenses, including, without limitation, any rights to any intellectual property owned, controlled or licensable by **ASSIGNOR** are granted or assigned to **ASSIGNEE** under this **ASSIGNMENT**, either expressly or by implication, estoppel, or otherwise, other than the rights expressly recited herein.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would knowingly conflict with this Agreement;

ASSIGNOR further covenants that **ASSIGNEE** will, upon its lawful request, reasonably be provided with all pertinent facts and documents relating to **THE ASSIGNED PATENT RIGHTS** and legal equivalents as may be known and reasonably accessible to **ASSIGNOR** and that **ASSIGNOR** will testify as to the same in any administrative contest or litigation related thereto and will promptly execute and deliver to **ASSIGNEE** or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce **THE ASSIGNED PATENT RIGHTS** and said equivalents in the United States or in any foreign country, which may be necessary or desirable to carry out the purposes thereof.

IN TESTIMONY WHEREOF, I hereunto set my hand as of the date indicated below.

SANDISK CORPORATION

Dated: 4th April 2011

Judy Bruner
Name: Judy Bruner
Title: EVP 2nd CFO

STATE OF California)
COUNTY OF Santa Clara) ss.

On this 4th day of April, 2011, before me Averil Branwen Watan (Notary Public), the undersigned Notary Public, personally appeared Judy Bruner,

who proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

I certify under PENALTY OF PERJURY under the laws of the State of California that the foregoing paragraph is true and correct.

WITNESS my hand and official seal.



Signature: Averil Watan
Signature of Notary Public

We accept the Assignment

SANDISK TECHNOLOGIES INC.

Dated: 4/4/11

James F. Brelsford
Name: James F. Brelsford
Title: President and Secretary

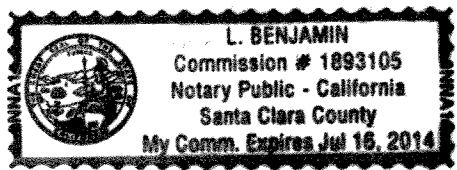
STATE OF California)
COUNTY OF Santa Clara) ss.

On this 4 day of April, 2011, before me L. Benjamin, the undersigned Notary Public, personally appeared JAMES F. BRELSFORD

who proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

I certify under PENALTY OF PERJURY under the laws of the State of California that the foregoing paragraph is true and correct.

WITNESS my hand and official seal.



Signature: L. Benjamin
Signature of Notary Public

Exhibit A

FILE #	INVENTORS	TITLE	COUNTRY	STATUS	SER #	FILING DATE	PAT #	ISSUE DATE
SDA-1255-US	Feng Pan, Trung Pham, Byungki Woo	Read Verify Word Line Reference Voltage to Track Source Level	US	Issued	11961917	20-Dec-07	7701761	20-Apr-10
SDA-1256-US	Gerrit Jan Hemink	Faster Programming of Multi-Level Non-Volatile Storage Through Reduced Verify Operations	US	Issued	11952295	7-Dec-07	7688638	30-Mar-10
SDA-1258-US	Takashi Orimoto, George Matamis, James Kai, Vinod Robert Purayath	Enhanced Endpoint Detection in Non-Volatile Memory Fabrication Processes	US	Published	11960485	19-Dec-07		
SDA-1259-I-US	Vinod Robert Purayath, George Matamis, Takashi Orimoto, James Kai	Composite Charge Storage Structure Formation in Non-Volatile Memory Using Etch Stop Technologies	US	Allowed	12615154	9-Nov-09		
SDA-1259-US	Vinod Robert Purayath, George Matamis, Takashi Orimoto, James Kai	Composite Charge Storage Structure Formation in Non-Volatile Memory Using Etch Stop Technologies	US	Issued	11960498	19-Dec-07	7615447	10-Nov-09
SDA-1260-US	Vinod Robert Purayath, George Matamis, Takashi Orimoto, James Kai	Lithographically Spaced-Defined Charge Storage Regions in Non-Volatile Memory	US	Issued	11960513	19-Dec-07	7807529	5-Oct-10
SDA-1261-US	Vinod Robert Purayath, George Matamis, Takashi Orimoto, James Kai	Non-Volatile Memory Fabrication and Isolation for Composite Charge Storage Structures	US	Issued	11960518	19-Dec-07	7888210	15-Feb-11
SDA-1262-US	Vinod Robert Purayath, George Matamis, Takashi Orimoto, James Kai, Tuan D. Pham	Method of forming memory with floating gates including self-aligned metal nanodots using a polymer solution	US	Pending	11958875	18-Dec-07		
SDA-1263-I-US	Vinod Robert Purayath, George Matamis, Takashi Orimoto, James Kai, Tuan D. Pham	Method of forming memory with floating gates including self-aligned metal nanodots using a coupling layer	US	Published	12754408	5-Apr-10		
SDA-1263-US	Vinod Robert Purayath, George Matamis, Takashi Orimoto, James Kai, Tuan D. Pham	Method of forming memory with floating gates including self-aligned metal nanodots using a coupling layer	US	Issued	11958941	18-Dec-07	7723186	25-May-10
SDA-1264-US	Alan Welsh Sinclair, Barry Wright	System and Method for Controlling an Amount of Unprogrammed Capacity in Memory Blocks of a Mass Storage System	US	Published	11963413	21-Dec-07		
SDA-1265-US	Sergey Anatolevich Gorobets	System and Method for Implementing Extensions to Intelligently Manage Resources of a Mass Storage System	US	Published	11963479	21-Dec-07		
SDA-1266-I-US	Masaaki Higashitani	Non-Volatile Storage with Substrate Cut-Out and Process of Fabricating	US	Pending	13043980	9-Mar-11		
SDA-1266-US	Masaaki Higashitani	Non-Volatile Storage with Substrate Cut-Out and Process of Fabricating	US	Allowed	11964445	26-Dec-07		
SDA-1267-US	Bill Thanos	MTP-Capable USB Device and Methods for Use Therewith	US	Published	12005547	26-Dec-07		
SDA-1268-US	Paul Lassa, Paul Paternoster, Po-Shen Lai	Optionally Bonding Either Two Sides or More Sides of Integrated Circuits	US	Pending	11966012	28-Dec-07		
SDA-1269-US	Daniel Nguyen, Steve Chi	Systems and Circuits with Multirange and Localized Detection of Valid Power	US	Issued	11965943	28-Dec-07	7830039	9-Nov-10
SDA-1270-US	Po-Shen Lai, Paul Lassa, Paul Paternoster	Exclusive-Option Chips and Methods with All-Options-Active Test Mode	US	Allowed	11966147	28-Dec-07		
SDA-1271-US	Hem Takiar, Shrikar Bhagath, Vincent (Ming Hsun) Lee, Bonnie Chan	TSOP LEADFRAME STRIP OF MULTIPLY ENCAPSULATED PACKAGES	US	Published	11965709	27-Dec-07		
SDA-1272-US	Suresh Upadhyayula, Bonnie Chan, Soencer Fan Chiang, Hem Takiar	ETCHED SURFACE MOUNT ISLANDS IN A LEADFRAME PACKAGE	US	Published	11966303	28-Dec-07		